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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: West et al.

Art Unit: 2822

Serial No.: 10/697,137

Examiner: Guerrero, M.

Filing Date: 10/30/2003

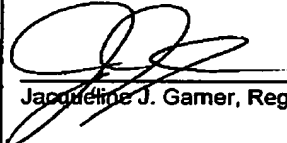
Docket No.: TI-36238

Customer No.: 23494

Conf. No.: 9756

Title: METHOD FOR IMPROVING RELIABILITY OF COPPER INTERCONNECTS

## CERTIFICATION OF FACSIMILE TRANSMISSION

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<b>NAME OF INVENTOR(S):</b> <b>WEST</b>	
<b>RECEIPT DATE &amp; SERIAL NO.:</b> <b>Serial No.: 10/697,137</b> <b>Filing Date: 10/30/2003</b> <b>Conf. No.: 9756</b>	
<b>TITLE OF INVENTION:</b> <b>METHOD FOR IMPROVING . . .</b>	
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